# MSKSEMI 美森科













**ESD** 

**ESD5ZXXX-MS** 

**Product specification** 





## **Features**

- IEC61000-4-2 Level 4 ESD Protection
- Protects one directional I/O line
- Low clamping voltage
- Working voltages: 2.5V,3.3V, 5V,6V,7V,12V
- Low leakage current

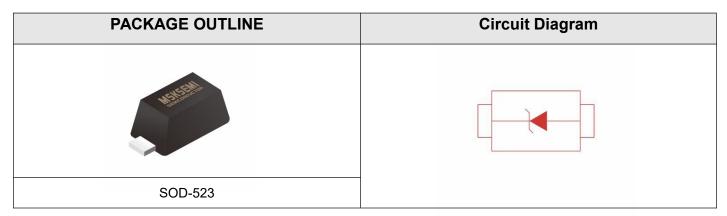
## **MACHANICAL DATA**

- SOD-523 package
- Flammability Rating: UL 94V-0
- Packaging: Tape and Reel
- High temperature soldering guaranted:260 ℃/10s
- Reel size: 7 inch

## **APPLICATIONS**

- Cell Phone Handsets and Accessories
- Microprocessor based equipment
- Personal Digital Assistants (PDA's)
- Notebooks, Desktops, and Servers
- Portable Instrumentation
- Peripherals
- Pagers

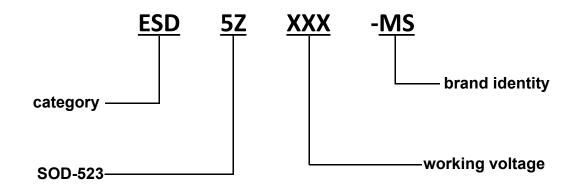
## **Reference News**



ESD5Z2.5V-MS	ESD5Z3V3-MS	ESD5Z5V0-MS	ESD5Z6V0-MS
ZD*	ZE*	ZF *	ZG*
ESD5Z7V0-MS	ESD5Z12V-MS	ESD5Z15V-MS	
ZH*	ZM*	ZN*	



## **Part Number Code**



## **ABSOLUTE MAXIMUM RATING**

Symbol	Parameter	Value	Units
V <sub>ESD</sub>	ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	±30 ±22	kV
ESD	ESD Voltage per human body model ESD Voltage per machine model	16 400	kV V
P <sub>D</sub>	Total Power Dissipation on FR-5 Board (Note 1) @ Ta=25	150	mW
T <sub>J,</sub> T <sub>STG</sub>	Junction and Storage Temperature	-55/+150	$^{\circ}$
TL	Lead Solder Temperature – Maximum (10 Second Duration)	260	${\mathbb C}$

These ratings are limiting values above which the serviceability of the diode may be impaired Note 1. FR-5=1.0x0.75x0.62 in.

# **ELECTRICAL CHARACTERISTICS (Tamb=25℃)**

	V <sub>RWM</sub>	I <sub>R</sub>	V <sub>B</sub>	l <sub>T</sub>	V	c	V	С	P <sub>PK</sub>	CJ
PART NUMBER	(V)	(µA)	(V)	(mA)	(\	<b>/</b> )	(\	<b>/</b> )	(W)	(pF)
17411101112111	Max	Max	Min		Max	@A	Max	@A	Max	Max
ESD5Z2V5-MS	2.5	1.0	4.0	1	9.0	5.0	20.0	13	150	110
ESD5Z3V3-MS	3.3	1.0	5.0	1	10.0	5.0	18.0	12	150	100
ESD5Z5V0-MS	5.0	1.0	6.2	1	11.6	5.0	17.0	11	150	95
ESD5Z6V0-MS	6.0	0.50	6.8	1	13.5	5.0	20.0	10	150	90
ESD5Z7V0-MS	7.0	0.50	7.5	1	14.0	5.0	21.0	9.0	150	80
ESD5Z12V-MS	12.0	0.50	14.1	1	20.0	1.0	28.0	7.0	150	45
ESD5Z15V-MS	15.0	0.50	16.0	1	23.0	1.0	35.0	5.0	150	35



## **ELECTRICAL CHARACTERISTICS CURVE**

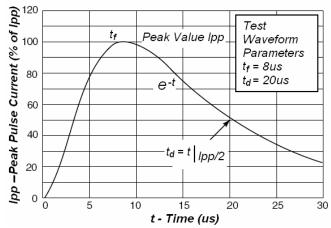


Fig1. Pulse Waveform

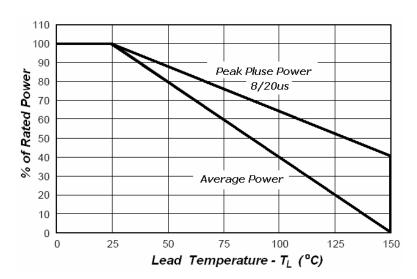
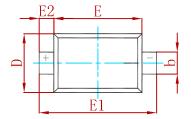
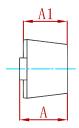


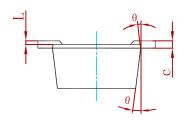
Fig3.Power Derating



## PACKAGE MECHANICAL DATA

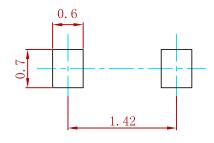






Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Syllibol	Min	Max	Min	Max	
Α	0.510	0.770	0.020	0.031	
A1	0.500	0.700	0.020	0.028	
b	0.250	0.350	0.010	0.014	
С	0.080	0.150	0.003	0.006	
D	0.750	0.850	0.030	0.033	
E	1.100	1.300	0.043	0.051	
E1	1.500	1.700	0.059	0.067	
E2	0.200 REF		0.008 REF		
L	0.010	0.070	0.001	0.003	
θ	7° REF		7° REF		

# **Suggested Pad Layout**



#### Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

## **REELSPECIFICATION**

P/N	PKG	QTY
ESD5ZXXX-MS	SOD-523	3000



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